

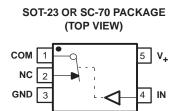
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Description

The TS5A4595 is a single-pole single-throw (SPST) analog switch that is designed to operate from 2 V to 5.5 V. This device can handle both digital and analog signals, and signals up to V_+ can be transmitted in either direction.

Applications

- Sample-and-Hold Circuit
- Battery-Powered Equipment (Cellular Phones, PDAs)
- Audio and Video Signal Routing
- Communication Circuits
- PCMCIA Cards



FUNCTION TABLE									
IN	NC TO COM, COM TO NC								
L	ON								
Н	OFF								

Features

- Low ON-State Resistance (8 Ω)
- ON-State Resistance Flatness (1.5 Ω)
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection (5 pC Max)
- 450-MHz –3-dB Bandwidth at 25°C
- Low Total Harmonic Distortion (THD) (0.04%)
- 2-V to 5.5-V Single-Supply Operation
- -82-dB OFF-Isolation at 1 MHz
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- 0.5-nA Max OFF Leakage
- ESD Performance Tested Per JESD 22

 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)
- TTL/CMOS-Logic Compatible

Summary of Characteristics

 $V_+ = 5 V$, $T_A = 25^{\circ}C$

Configuration	Single Pole Single Throw (SPST)
Number of channels	1
ON-state resistance (r _{on})	8 Ω
ON-state resistance flatness (ron(flat))	1.5 Ω
Turn-on/turn-off time (tON/tOFF)	17 ns/14 ns
Charge injection (Q _C)	5 pC
Bandwidth (BW)	450 MHz
OFF isolation (O _{ISO})	–82 dB at 1 MHz
Total harmonic distortion (THD)	0.04%
Leakagecurrent(ICOM(OFF)/INC(OFF))	±0.5 nA
Power-supply current (I+)	0.25 μΑ
Package option	5-pin SOT-23 or SC-70

ORDERING INFORMATION

TA	PACKAGE(1)		ORDERABLE PART NUMBER	TOP-SIDE MARKING(2)
4000 10 0500	SOT (SOT-23) – DBV	Tape and reel	TS5A4595DBVR	JSB_
–40°C to 85°C	SOT (SC-70) – DCK	Tape and reel	TS5A4595DCKR	JT_

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
(2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

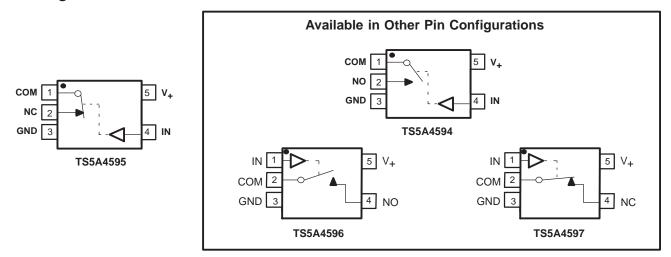


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Pin Configurations



Absolute Minimum and Maximum Ratings⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
۷+	Supply voltage range ⁽³⁾		-0.3	6	V
V _{NC} V _{COM}	Analog voltage range(3)(4)		-0.3	V ₊ + 0.3	V
١ĸ	Analog port diode current	V _{NC} , V _{COM} < 0	-50		mA
I _{NC} ICOM	On-state switch current	V_{NC} , $V_{COM} = 0$ to V_+	-20	20	mA
VI	Digital input voltage range $(3)(4)$		-0.3	6	V
ΙIK	Digital input clamp current	V _I < 0	-50		mA
I ₊	Continuous current through V+			100	mA
IGND	Continuous current through GND		-100		mA
	De de se (h ser el instal i el se (5)	DBV package		206	
θJA	Package thermal impedance ⁽⁵⁾	DCK package		252	°C/W
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

(3) All voltages are with respect to ground, unless otherwise specified.

(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(5) The package thermal impedance is calculated in accordance with JESD 51-7.

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Electrical Characteristics for 5-V Supply(1) $V_+ = 4.5 V$ to 5.5 V, $V_{IH} = 2.4 V$, $V_{IL} = 0.8 V T_A = -40^{\circ}C$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	IS	TA	V+	MIN	TYP	MAX	UNIT
Analog Switch	1	I		1 1		1			
Analog signal range	VCOM, VNC					0		V+	V
ON-state		V ₊ = 4.5 V, V _{NC} = 3.5 V,	Switch ON,	25°C	451/		5	8	Ω
resistance	ron	$I_{COM} = 10 \text{ mA},$	See Figure 13	Full	4.5 V			10	52
ON-state		V _{NC} = 1.5 V, 2.5 V, 3.5 V,	Switch ON,	25°C	4 5 14		0.5	1.5	0
resistance flatness	ron(flat)	$I_{COM} = 10 \text{ mA},$	See Figure 13	Full	4.5 V			2	Ω
NC		V _{NC} = 1 V, V _{COM} = 4.5 V,	Switch OFF,	25°C		-0.5	0.01	0.5	
OFF leakage current	INC(OFF)	or V _{NC} = 4.5 V, V _{COM} = 1 V,	See Figure 14	Full	5.5 V	-5		5	nA
COM		V _{COM} = 1 V, V _{NC} = 4.5 V,	Switch OFF,	25°C		-0.5	0.01	0.5	nA
OFF leakage current	ICOM(OFF)	$v_{COM} = 4.5 \text{ V}, \text{ V}_{NC} = 1 \text{ V},$	See Figure 14	Full	5.5 V	-5		5	
NC		$V_{NC} = 1 V, V_{COM} = 1 V,$ or	Switch ON,	25°C		-1	0.01	1	
ON leakage current	INC(ON)	$V_{NC} = 4.5 V, V_{COM} = 4.5 V,$ or $V_{NC} = 1 V, 4.5 V, V_{COM} = Open,$	See Figure 15	Full	5.5 V	-10		10	nA
СОМ		$V_{COM} = 1 V, V_{NC} = 1 V,$ or	Switch ON,	25°C		-1	0.01	1	nA
ON leakage current	ICOM(ON)	$V_{COM} = 4.5 V, V_{NC} = 4.5 V,$ or $V_{COM} = 1 V, 4.5 V, V_{NC} = Open,$	See Figure 15	Full	5.5 V	-10		10	
Digital Control In	put (IN)								
Input logic high	VIH			Full		2.4		5.5	V
Input logic low	VIL			Full		0		0.8	V
Input leakage	1 _{1H} , 1 _{IL}	$V_{I} = V_{+}$ or 0		25°C	5.5 V	-0.5	0.01	0.5	μA
current	111/16			Full		-5		5	



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Electrical Characteristics for 5-V Supply⁽¹⁾ (continued) $V_{+} = 4.5 V \text{ to } 5.5 V$, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CON	DITIONS	TA	V+	MIN	TYP	MAX	UNIT
Dynamic		•		1					
Turn-on time	4	V _{NC} = 3 V,	C _L = 35 pF,	25°C	5 V		12	17	
rum-on time	^t ON	RL = 300 Ω,	See Figure 17	Full	4.5 V to 5.5 V			19	ns
Turn-off time	torr	V _{NC} = 3 V,	C _L = 35 pF,	25°C	5 V		9	14	ns
Turn-oir time	tOFF	R _L = 300 Ω,	See Figure 17	Full	4.5 V to 5.5 V			17	115
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,			4.5 V to 5.5 V		2	5	pC
NC OFF capacitance	C _{NC(OFF)}	$V_{NC} = 0$, f = 1 MHz, Switch OFF,	See Figure 16	25°C	5 V		6.5		pF
COM OFF capacitance	CCOM(OFF)	$V_{COM} = 0, f = 1 MHz,$ Switch OFF,	See Figure 16	25°C	5 V		6.5		pF
NC ON capacitance	C _{NC(ON))}	V _{NC} = 0, f = 1 MHz, Switch ON,	See Figure 16	25°C	5 V		13		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = GND, f = 1 MHz,$ Switch ON,	See Figure 16	25°C	5 V		13		pF
Digital input capacitance	CI	$V_{I} = V_{+}$ or GND,	See Figure 16	25°C	5 V		3		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON, Signal = 0 dBm	See Figure 18	25°C	5 V		450		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, $V_{NC} = 1 V_{RMS}$ f = 1 MHz, $C_L = 5 pF$	Switch OFF, See Figure 19	25°C	5 V		-82		dB
Total harmonic distortion	THD	R _L = 600 Ω, C _L = 50 pF, VSOURCE = 5 V _{p-p} ,	f = 20 Hz to 20 kHz, See Figure 21	25°C	5 V		0.04		%
Supply		•							
Positive supply				25°C	5.5.4		0.01	0.25	•
current	I+	$V_I = V_+ \text{ or GND},$	Switch ON or OFF	Full	5.5 V			0.5	μA

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Electrical Characteristics for 3-V Supply(1) $V_{+} = 2.7 V \text{ to } 3.6 V$, $T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	NS	TA	V+	MIN	TYP	MAX	UNIT
Analog Switch					•	•			
Analog signal range	V _{COM} , V _{NC}					0		V+	V
ON-state	r	$V_{+} = 3 V$, $V_{NC} = 1.5 V$, Switch ON,		25°C	2.7 V		9.5	16	Ω
resistance	ron	I _{COM} = 10 mA,	See Figure 13	Full	2.7 V			20	22
ON-state resistance		V _{NC} = 1.5 V, 2.5 V,	Switch ON,	25°C	271		1.8	6	Ω
flatness	ron(flat)	$I_{COM} = 10 \text{ mA},$	See Figure 13	Full	2.7 V			7	52
NC		$V_{NC} = 1 V, V_{COM} = 3 V,$	Switch OFF,	25°C	0.014	-0.5	0.01	0.5	
OFF leakage current	INC(OFF)	$v_{NC} = 3 V, V_{COM} = 1 V,$	See Figure 14	Full	3.6 V	-5		5	nA
COM OFF leakage current		$V_{COM} = 1 V, V_{NC} = 3 V,$	Switch OFF,	25°C	3.6 V	-0.5	0.01	0.5	nA
	ICOM(OFF)	$v_{COM} = 1 \text{ V}, v_{NC} = 3 \text{ V},$	See Figure 14	Full		-5		5	
NC		$V_{NC} = 1 V, V_{COM} = 1 V,$ or	Switch ON,	25°C		-1	0.01	1	
ON leakage current	I _{NC} (ON)	$V_{NC} = 3 V$, $V_{COM} = 3 V$, or $V_{NC} = 1 V$, $3 V$, $V_{COM} = Open$,	See Figure 15	Full	3.6 V	-10		10	nA
COM		$V_{COM} = 1 V, V_{NC} = 1 V,$	Switch ON,	25°C		-1	0.01	1	
ON leakage current	ICOM(ON)	$V_{COM} = 3 V, V_{NC} = 3 V,$ or $V_{COM} = 1 V, 3 V, V_{NC} = Open,$	See Figure 15	Full	3.6 V	-10		10	nA
Digital Control In	put (IN)	· · · · · · · · · · · · · · · · · · ·							
Input logic high	VIH			Full		2		5.5	V
Input logic low	VIL			Full		0		0.8	V
Input leakage current	IIH, IIL	$V_{I} = V_{+} \text{ or } 0$		25°C Full	3.6 V	-0.5 -5	0.01	0.5 5	nA



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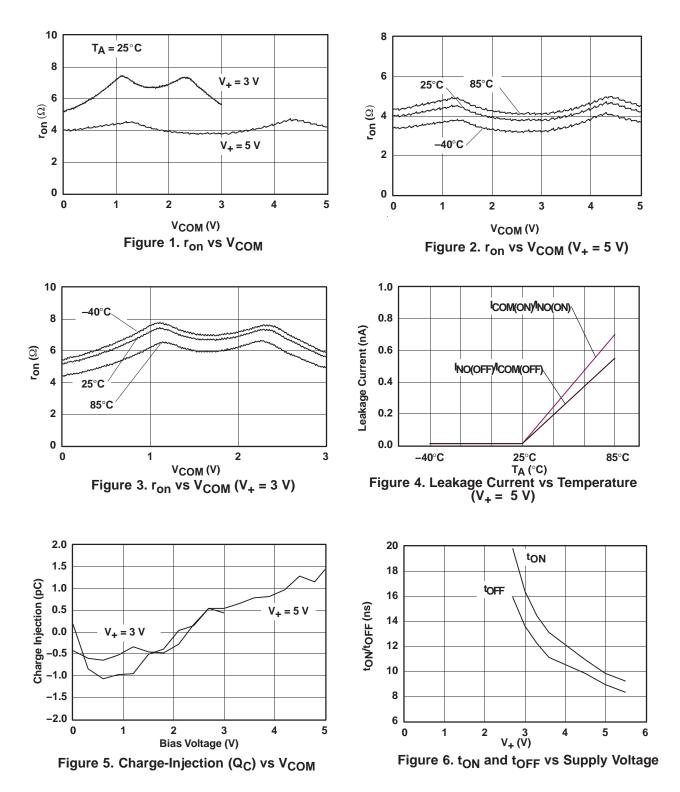
Electrical Characteristics for 3-V Supply⁽¹⁾ (continued) $V_{+} = 2.7 V \text{ to } 3.6 V, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CONDITIONS		TA	V+	MIN	TYP	MAX	UNIT
Dynamic	•	·							
Turn-on time	4	V _{NC} = 2 V,	CL = 35 pF,	25°C	3 V		20	30	
rum-on ume	tON	RL = 300 Ω,	See Figure 17	Full	2.7 V to 3.6 V			35	ns
Turn-off time	torr	$V_{NC} = 2 V,$	C _L = 35 pF,	25°C	3 V		15	25	ns
	tOFF	R _L = 300 Ω,	See Figure 17	Full	2.7 V to 3.6 V			30	115
Charge injection	QC	V _{GEN} = 0, R _{GEN} = 0, C _L = 1 nF,	See Figure 20	25°C	3 V		1	4	рС
NC OFF capacitance	C _{NC(OFF)}	$V_{NC} = 0$, f = 1 MHz, Switch OFF,	See Figure 16	25°C	3 V		6.5		pF
COM OFF capacitance	CCOM(OFF)	$V_{COM} = 0, f = 1 MHz,$ Switch OFF,	See Figure 16	25°C	3 V		6.5		pF
NC ON capacitance	C _{NC(ON)}	V _{NC} = 0, f = 1 MHz, Switch ON,	See Figure 16	25°C	3 V		13		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = 0, f = 1 MHz,$ Switch ON,	See Figure 16	25°C	3 V		13		pF
Digital input capacitance	Cl	$V_{I} = V_{+}$ or GND,	See Figure 16	25°C	3 V		3		pF
Bandwidth	BW	$R_L = 50 \Omega$, Signal = 0 dBm,	Switch ON, See Figure 18	25°C	3 V		450		MHz
OFF isolation	O _{ISO}	$\label{eq:RL} \begin{array}{l} R_L = 50 \ \Omega, \ C_L = 5 \ pF, \\ f = 1 \ MHz, \ V_{NC} = 1 \ V_{RMS}, \end{array}$	Switch OFF, See Figure 19	25°C	3 V		-82		dB
Total harmonic distortion	THD	$R_L = 600 \Omega$, $C_L = 50 pF$, VSOURCE = 3 V _{p-p} ,	f = 20 Hz to 20 kHz, See Figure 21	25°C	3 V		0.09		%
Supply		•		•					
Positive supply				25°C	0.01/		0.01	0.25	•
current	l+	$V_{I} = V_{+}$ or GND,	Switch ON or OFF	Full	3.6 V			0.5	μA



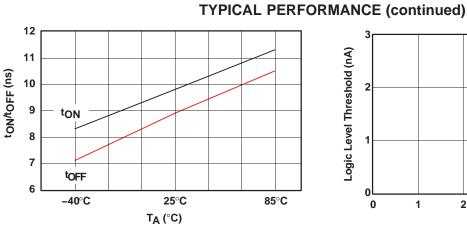
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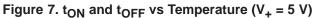
TYPICAL PERFORMANCE

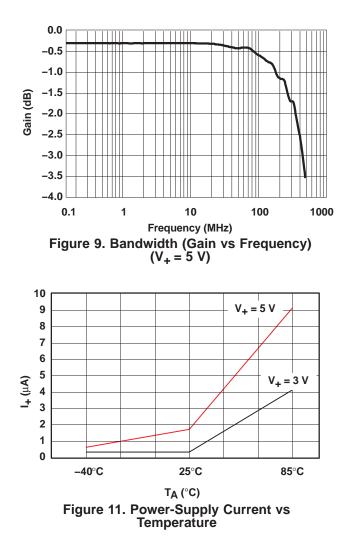




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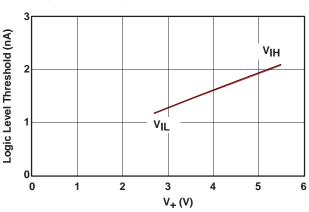


Figure 8. Logic-Level Threshold vs V₊

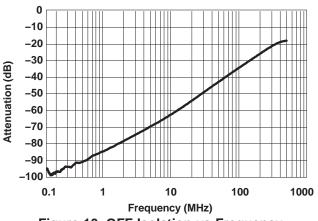
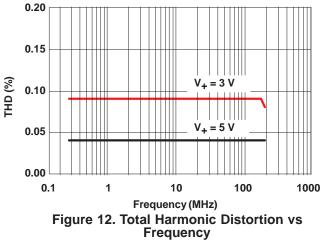


Figure 10. OFF Isolation vs Frequency



$\begin{array}{l} \textbf{TS5A4595}\\ \textbf{8-}\Omega \text{ SPST ANALOG SWITCH}\\ \textbf{5-V/3.3-V SINGLE-CHANNEL ANALOG SWITCH} \end{array}$

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PIN DESCRIPTION

PIN NUMBER	NAME	DESCRIPTION
1	COM	Common
2	NC	Normally closed
3	GND	Digital ground
4	IN	Digital control pin to connect COM to NC
5	V+	Power supply

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
VCOM	Voltage at COM
V _{NC}	Voltage at NC
ron	Resistance between COM and NC ports when the channel is ON
ron(flat)	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions
INC(OFF)	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state
I _{NC(ON)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open
ICOM(OFF)	Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the OFF state
ICOM(ON)	Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the ON state and the output (NC) open
VIH	Minimum input voltage for logic high for the control input (IN)
VIL	Maximum input voltage for logic low for the control input (IN)
VI	Voltage at the control input (IN)
I _{IH} , I _{IL}	Leakage current measured at the control input (IN)
tON	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning ON.
^t OFF	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning OFF.
QC	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance, and ΔV_{COM} is the change in analog output voltage.
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
C _{COM(OFF)}	Capacitance at the COM port when the corresponding channel (COM to NC) is OFF
C _{COM} (ON)	Capacitance at the COM port when the corresponding channel (COM to NC) is ON
Cl	Capacitance of control input (IN)
O _{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM) in the OFF state.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.
l ₊	Static power-supply current with the control (IN) pin at V+ or GND



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PARAMETER MEASUREMENT INFORMATION

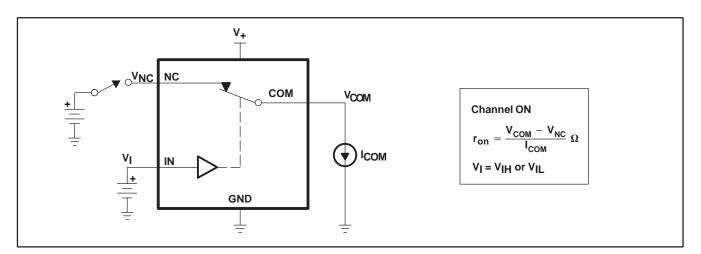


Figure 13. ON-State Resistance (ron)

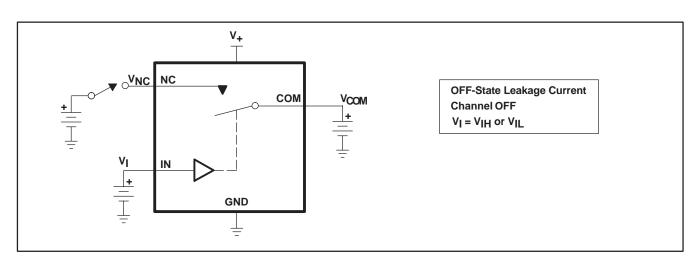
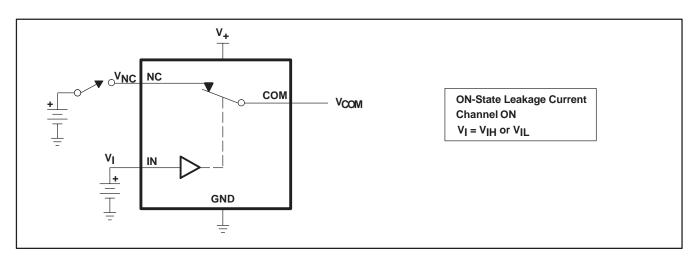


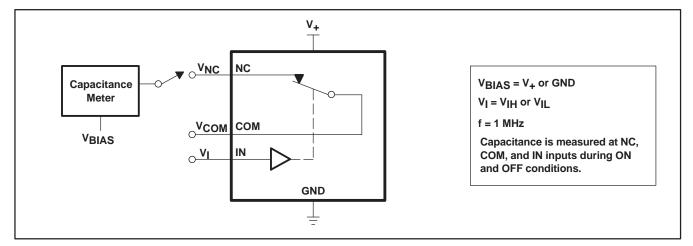
Figure 14. OFF-State Leakage Current (I_{COM(OFF)}, I_{NC(OFF)})



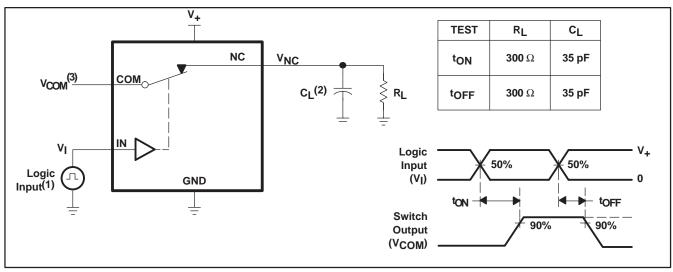




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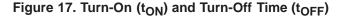


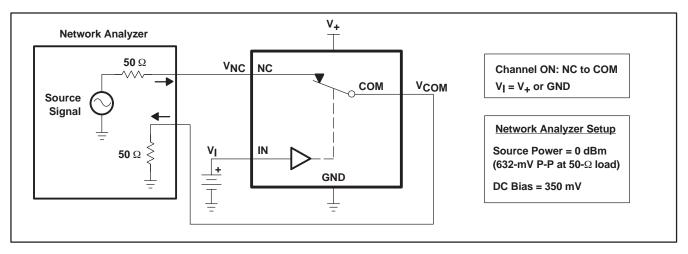


(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f < 5 ns, t_f < 5 ns.

(2) C_L includes probe and jig capacitance.

(3) See Electrical Characteristics for V_{COM}.









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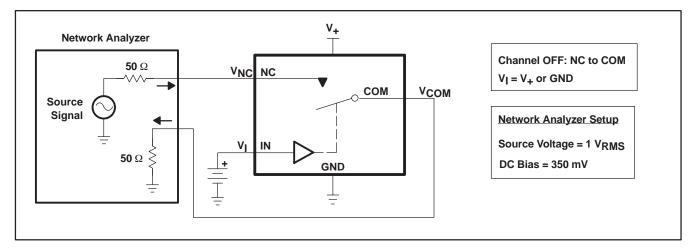
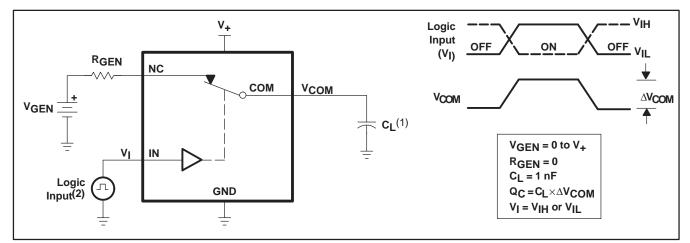


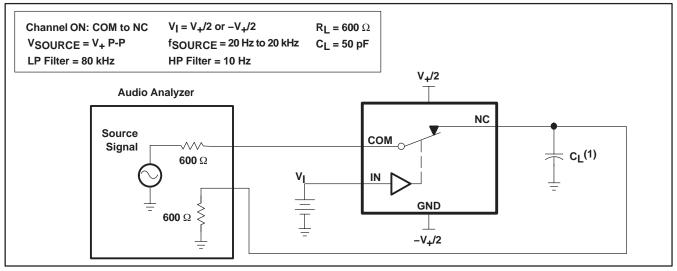
Figure 19. OFF Isolation (OISO)



(1) C_L includes probe and jig capacitance.

(2) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f < 5 ns, t_f < 5 ns.

Figure 20. Charge Injection (Q_C)



(1) CL includes probe and jig capacitance.





PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
TS5A4595DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 85	JSBR
TS5A4595DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	JSBR
TS5A4595DCKR	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JT5, JTF, JTR)
TS5A4595DCKR.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JT5, JTF, JTR)
TS5A4595DCKRG4	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	JTF
TS5A4595DCKRG4.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	JTF

⁽¹⁾ **Status:** For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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PACKAGE OPTION ADDENDUM

17-Jun-2025

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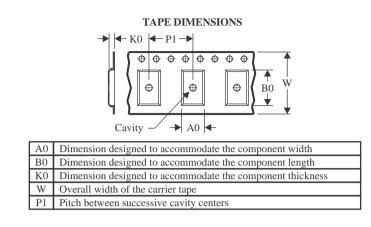
Texas

*All dimensions are nominal

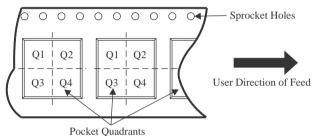
STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A4595DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TS5A4595DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.23	3.17	1.37	4.0	8.0	Q3
TS5A4595DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TS5A4595DCKRG4	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3

Q3 | Q4



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PACKAGE MATERIALS INFORMATION

5-Jul-2025



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A4595DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TS5A4595DBVR	SOT-23	DBV	5	3000	202.0	201.0	28.0
TS5A4595DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TS5A4595DCKRG4	SC70	DCK	5	3000	180.0	180.0	18.0

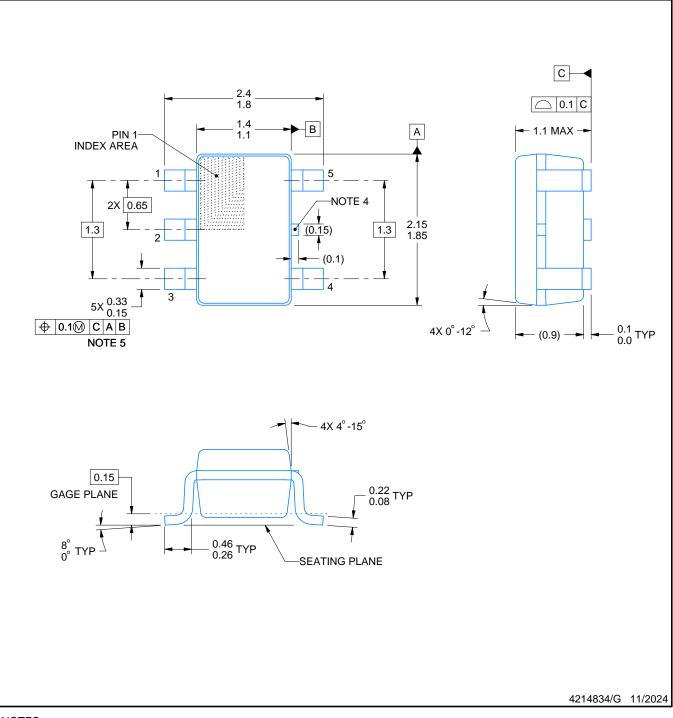
DCK0005A



PACKAGE OUTLINE

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



DCK0005A

EXAMPLE BOARD LAYOUT

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

Publication IPC-7351 may have alternate designs.
Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DCK0005A

EXAMPLE STENCIL DESIGN

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

10. Board assembly site may have different recommendations for stencil design.



DBV0005A



PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



DBV0005A

EXAMPLE BOARD LAYOUT

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DBV0005A

EXAMPLE STENCIL DESIGN

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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